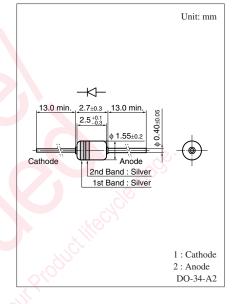
MA2C719 (MA719)

Silicon epitaxial planar type

For high frequency rectification

Features

- $I_{F(AV)} = 500 \text{ mA}$ rectification is possible
- High-density mounting (5 mm pitch insertion) is possible
- Optimum for high frequency rectification because of its short reverse recovery time t_{rr}
- Low forward voltage V_F and good rectification efficiency



Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter

	- J		
Reverse voltage	V _R	40	V
Repetitive peak reverse voltage	V _{RRM}	40	V
Forward current (Average)	I _{F(AV)}	500	mA
Peak forward current	I _{FM}	1	А
Non-repetitive peak forward surge current *	I _{FSM}	3	A
Junction temperature	Tj	125	°C
Storage temperature	T _{stg}	-55 to +150	°C

Symbol Rating

Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

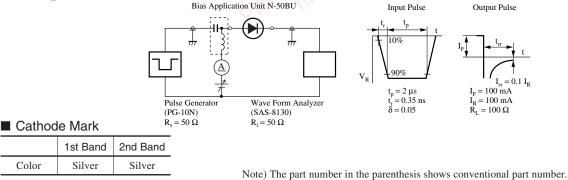
	u					
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _F	$I_F = 500 \text{ mA}$	02	$\mathcal{O}_{U_{i}}$	0.55	V
Reverse current	IR	V _R = 35 V	0.	82	100	μΑ
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$	000	60		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}$	0	5		ns
le contraction de la contracti		$I_{rr} = 0.1 I_R, R_L = 100 \Omega$				

Unit

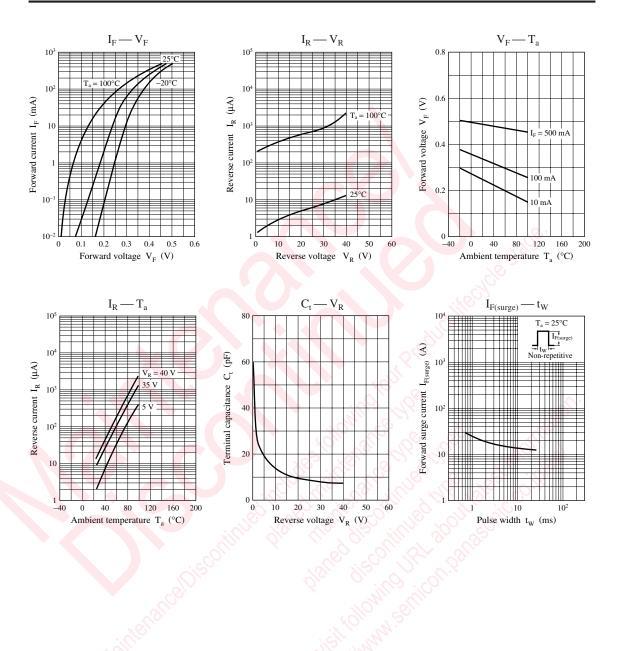
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

- 3. Absolute frequency of input and output is 400 GHz.
- 4.*: t_{rr} measurement circuit



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